

# NIKO-SEM Dual P-Channel Logic Level Enhancement Mode Field Effect Transistor P06B03LVG

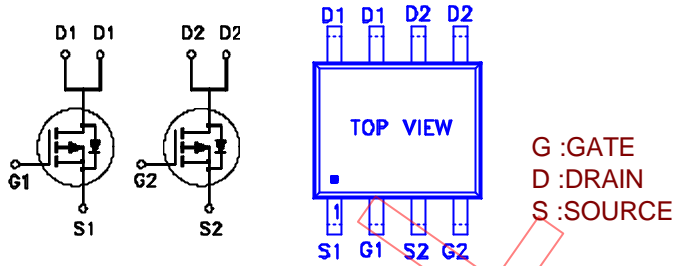
Mode Field Effect Transistor

SOP-8

Lead Free

## PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
-30	50m	-6A



## ABSOLUTE MAXIMUM RATINGS ( $T_C = 25\text{ }^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		$V_{DS}$	-30	V
Gate-Source Voltage		$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$T_C = 25\text{ }^\circ\text{C}$	$I_D$	-6	A
	$T_C = 70\text{ }^\circ\text{C}$		-5	
Pulsed Drain Current <sup>1</sup>		$I_{DM}$	-30	
Power Dissipation	$T_C = 25\text{ }^\circ\text{C}$	$P_D$	2.5	W
	$T_C = 70\text{ }^\circ\text{C}$		1.3	
Operating Junction & Storage Temperature Range		$T_j, T_{stg}$	-55 to 150	$^\circ\text{C}$
Lead Temperature ( $1/16''$ from case for 10 sec.)		$T_L$	275	

## THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient	$R_{\theta JA}$		62.5	$^\circ\text{C} / \text{W}$

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>Duty cycle  $\leq 1\%$

## ELECTRICAL CHARACTERISTICS ( $T_C = 25\text{ }^\circ\text{C}$ , Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-30			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-0.9	-1.5	-3	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 20V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -24V, V_{GS} = 0V$			1	$\mu A$
		$V_{DS} = -20V, V_{GS} = 0V, T_J = 125\text{ }^\circ\text{C}$			10	
On-State Drain Current <sup>1</sup>	$I_{D(ON)}$	$V_{DS} = -5V, V_{GS} = -10V$	-30			A
Drain-Source On-State Resistance <sup>1</sup>	$R_{DS(ON)}$	$V_{GS} = -4.5V, I_D = -5A$		65	80	m
		$V_{GS} = -10V, I_D = -6A$		40	50	

# NIKO-SEM Dual P-Channel Logic Level Enhancement P06B03LVG

## Mode Field Effect Transistor

SOP-8

Lead Free

Forward Transconductance <sup>1</sup>	$g_{fs}$	$V_{DS} = -10V, I_D = -6A$	16	S
<b>DYNAMIC</b>				
Input Capacitance	$C_{iss}$	$V_{GS} = 0V, V_{DS} = -15V, f = 1MHz$	530	pF
Output Capacitance	$C_{oss}$		135	
Reverse Transfer Capacitance	$C_{rss}$		70	
Total Gate Charge <sup>2</sup>	$Q_g$	$V_{DS} = 0.5V_{(BR)DSS}, V_{GS} = -10V, I_D = -6A$	10	14
Gate-Source Charge <sup>2</sup>	$Q_{gs}$		2.2	nC
Gate-Drain Charge <sup>2</sup>	$Q_{gd}$		2	
Turn-On Delay Time <sup>2</sup>	$t_{d(on)}$	$V_{DS} = -15V, R_L = 1\Omega, I_D \cong -1A, V_{GS} = -10V, R_{GS} = 6\Omega$	5.7	nS
Rise Time <sup>2</sup>	$t_r$		10	
Turn-Off Delay Time <sup>2</sup>	$t_{d(off)}$		18	
Fall Time <sup>2</sup>	$t_f$		5	
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (<math>T_C = 25\text{ }^\circ\text{C}</math>)</b>				
Continuous Current	$I_S$		-2.1	A
Pulsed Current <sup>3</sup>	$I_{SM}$		-4	
Forward Voltage <sup>1</sup>	$V_{SD}$	$I_F = -1A, V_{GS} = 0V$	-1.2	V
Reverse Recovery Time	$t_{rr}$	$I_F = -5A, dI_F/dt = 100A/\mu S$	15.5	nS
Reverse Recovery Charge	$Q_{rr}$		7.9	nC

<sup>1</sup>Pulse test : Pulse Width  $\leq 300\ \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .

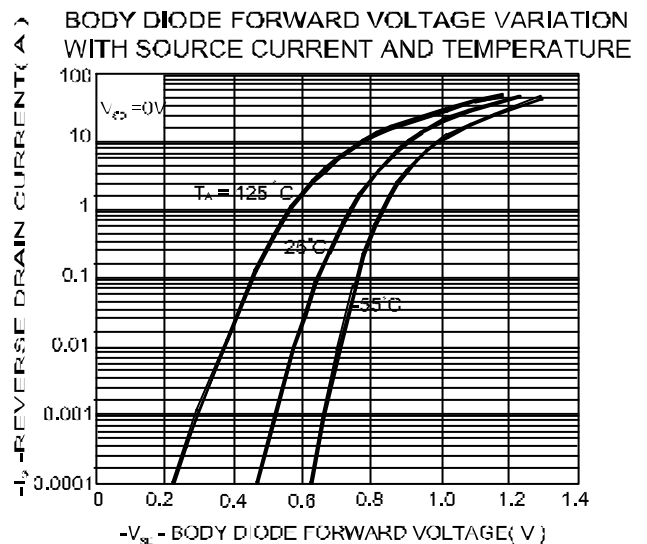
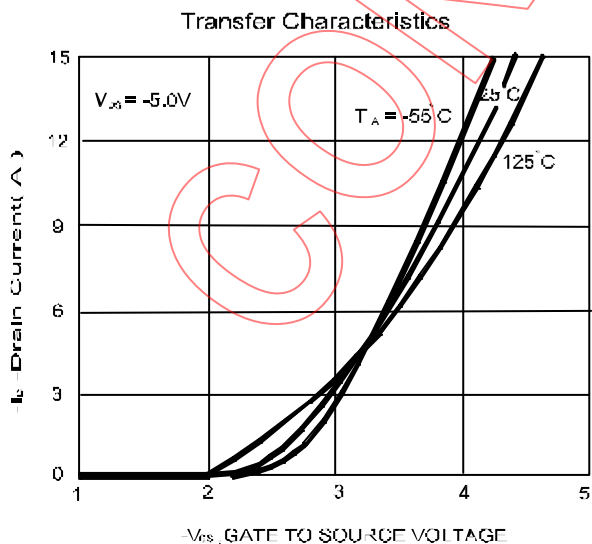
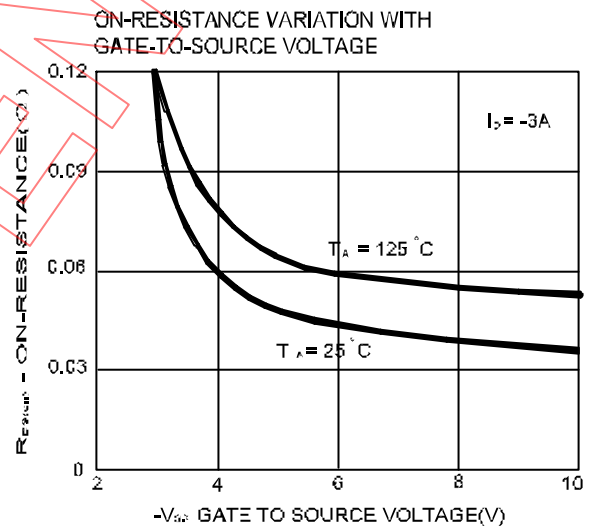
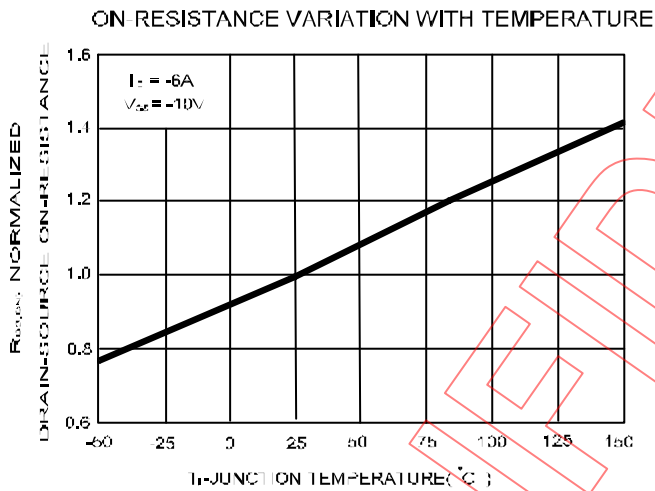
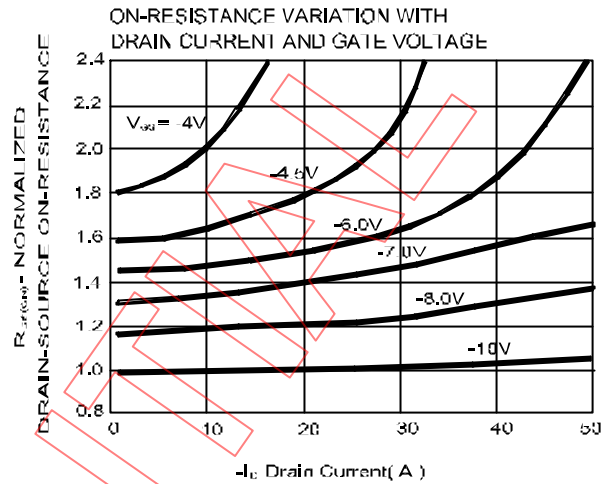
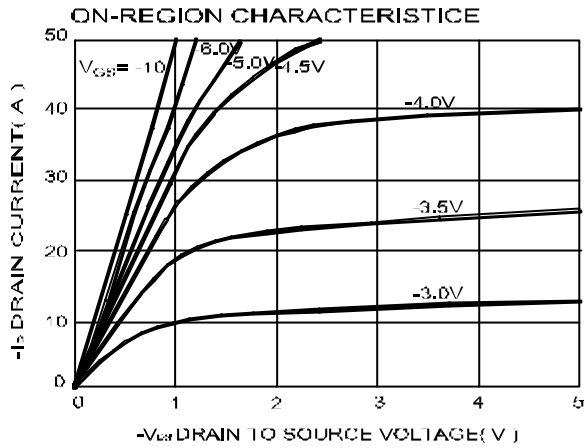
<sup>2</sup>Independent of operating temperature.

<sup>3</sup>Pulse width limited by maximum junction temperature.

**REMARK: THE PRODUCT MARKED WITH "P06B03LVG", DATE CODE or LOT #**

**Orders for parts with Lead-Free plating can be placed using the PXXXXXXG parts name.**

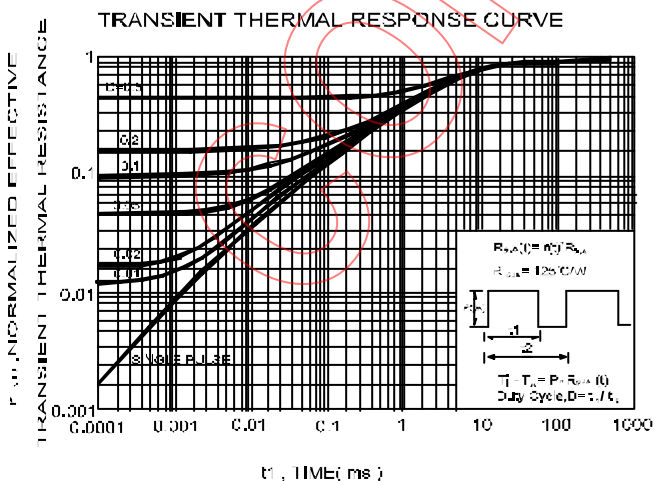
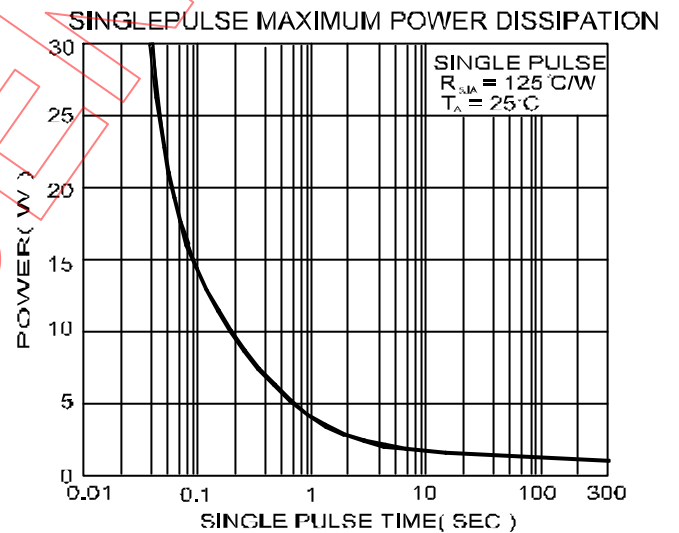
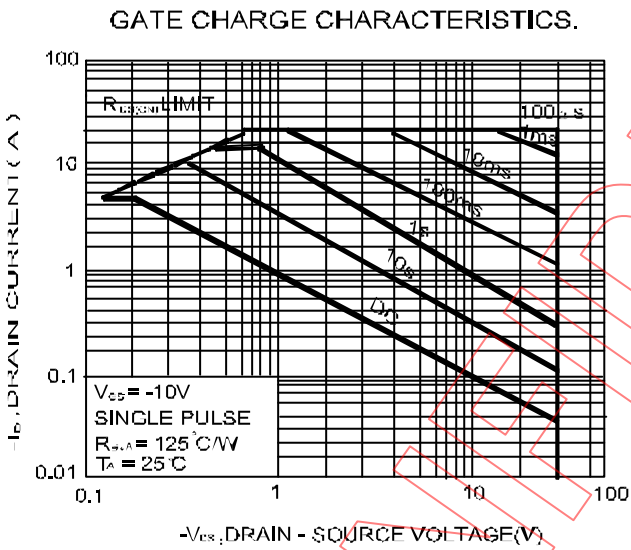
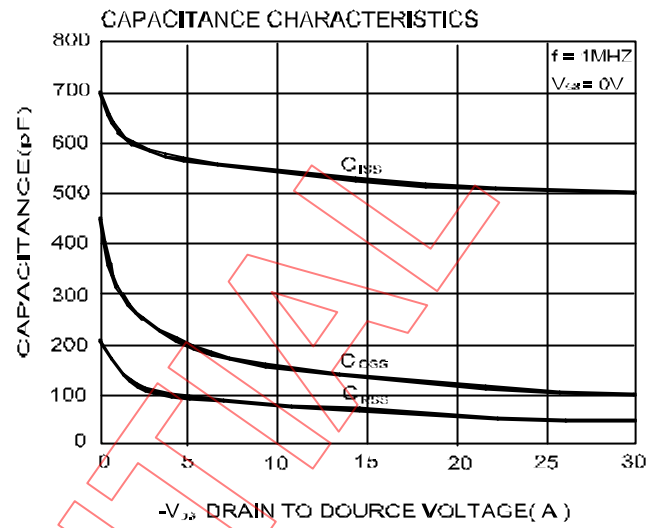
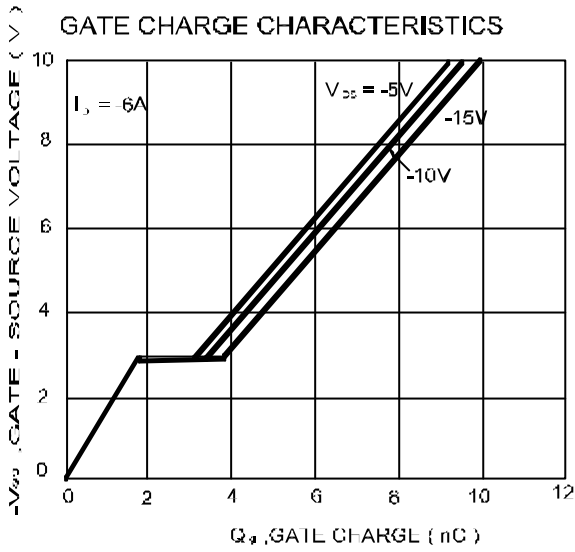
## Typical Characteristics



# NIKO-SEM Dual P-Channel Logic Level Enhancement P06B03LVG Mode Field Effect Transistor

SOP-8

Lead Free



**SOIC-8 (D) MECHANICAL DATA**

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	4.8	4.9	5.0	H	0.5	0.715	0.83
B	3.8	3.9	4.0	I	0.18	0.254	0.25
C	5.8	6.0	6.2	J		0.22	
D	0.38	0.445	0.51	K	0°	4°	8°
E		1.27		L			
F	1.35	1.55	1.75	M			
G	0.1	0.175	0.25	N			

